Electronic Patent Application Fee Transmittal							
Application Number:	10774869						
Filing Date:	09-Feb-2004						
Title of Invention:	Underfill process for flip-chip device						
First Named Inventor/Applicant Name:	Song-Hua Shi						
Filer:	Suneel Arora/Amy Moriarty						
Attorney Docket Number:	2827.035US2						
Filed as Large Entity							
Utility under 35 USC 111(a) Filing Fees							
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)		
Basic Filing:							
Pages:							
Claims:							
Miscellaneous-Filing:							
Petition:							
Patent-Appeals-and-Interference:							
Post-Allowance-and-Post-Issuance:							
Extension-of-Time:							
Extension - 2 months with \$0 paid		1252	1	490	490		

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
	Total in USD (\$)			490